

January 2008

74LVT240, 74LVTH240 Low Voltage Octal Buffer/Line Driver with 3-STATE Outputs

Features

- Input and output interface capability to systems at 5V V_{CC}
- Bushold data inputs eliminate the need for external pull-up resistors to hold unused inputs (74LVTH240), also available without bushold feature (74LVT240)
- Live insertion/extraction permitted
- Power Up/Down high impedance provides glitch-free bus loading
- Outputs source/sink –32mA/+64mA
- Functionally compatible with the 74 series 240
- Latch-up performance exceeds 500mA
- ESD performance:
 - Human-body model > 2000V
 - Machine model > 200V

Ordering Information

Charged-device model > 1000V

General Description

The LVT240 and LVTH240 are inverting octal buffers and line drivers designed to be employed as memory address drivers, clock drivers and bus oriented transmitters or receivers which provides improved PC board density.

The LVTH240 data inputs include bushold, eliminating the need for external pull-up resistors to hold unused inputs.

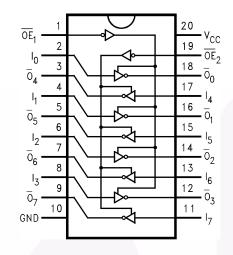
These octal buffers and line drivers are designed for lowvoltage (3.3V) V_{CC} applications, but with the capability to provide a TTL interface to a 5V environment. The LVT240 and LVTH240 are fabricated with an advanced BiCMOS technology to achieve high speed operation similar to 5V ABT while maintaining low power dissipation.

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Order Number	Package Number	Package Description			
74LVT240WM	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide			
74LVT240SJ	M20D	Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide			
74LVT240MSA	MSA20	20-Lead Shrink Small Outline Package (SSOP), JEDEC MO-150, 5.3mm Wide			
74LVT240MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide			
74LVTH240WM	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide			
74LVTH240SJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide			
74LVTH240MSA	MSA20	20-Lead Shrink Small Outline Package (SSOP), JEDEC MO-150, 5.3mm Wide			
74LVTH240MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide			

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

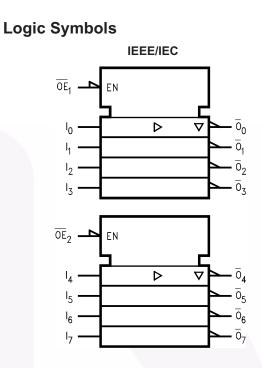
All packages are lead free per JEDEC: J-STD-020B standard.

Connection Diagrams



Pin Descriptions

Pin Names	Description
$\overline{OE}_1, \overline{OE}_2$	3-STATE Output Enable Inputs
I ₀ —I ₇	Inputs
$\overline{O}_0 - \overline{O}_7$	3-STATE Outputs



Truth Tables

Inp	uts	Outputs
OE ₁	I _n	(Pins 12, 14, 16, 18)
L	L	Н
L	Н	L
Н	Х	Z

Inp	uts	Outputs
\overline{OE}_2	I _n	(Pins 3, 5, 7, 9)
L	L	Н
L	Н	L
Н	Х	Z

H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial

Z = High Impedance

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V _{CC}	Supply Voltage	-0.5V to +4.6V
VI	DC Input Voltage	-0.5V to +7.0V
Vo	DC Output Voltage	
	Output in 3-STATE	-0.5V to +7.0V
	Output in HIGH or LOW State ⁽¹⁾	-0.5V to +7.0V
I _{IK}	DC Input Diode Current, V _I < GND	–50mA
I _{OK}	DC Output Diode Current, V _O < GND	–50mA
Ι _Ο	DC Output Current, $V_O > V_{CC}$	
	Output at HIGH State	64mA
	Output at LOW State	128mA
I _{CC}	DC Supply Current per Supply Pin	±64mA
I _{GND}	DC Ground Current per Ground Pin	±128mA
T _{STG}	Storage Temperature	–65°C to +150°C

Note:

1. I_O Absolute Maximum Rating must be observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min	Max	Units
V _{CC}	Supply Voltage	2.7	3.6	V
VI	Input Voltage	0	5.5	V
I _{OH}	HIGH-Level Output Current		-32	mA
I _{OL}	LOW-Level Output Current		64	mA
T _A	Free-Air Operating Temperature	-40	85	°C
$\Delta t / \Delta V$	Input Edge Rate, $V_{IN} = 0.8V - 2.0V$, $V_{CC} = 3.0V$	0	10	ns/V

			V _{cc}		T _A =–40°C to +85°C				
Symbol	Param	eter	(V)	Conditions	Min.	Typ. ⁽²⁾	Max.	Units	
V _{IK}	Input Clamp Did	ode Voltage	2.7	I _I = -18mA			-1.2	V	
V _{IH}	Input HIGH Volt	age	2.7–3.6	$V_0 \le 0.1 V$ or	2.0			V	
V _{IL}	Input LOW Voltage		2.7–3.6	$V_{O} \ge V_{CC} - 0.1V$			0.8	V	
V _{OH}	Output HIGH Vo	oltage	2.7–3.6	I _{OH} = -100μA	V _{CC} -0.2			V	
			2.7	I _{OH} = -8mA	2.4			1	
			3.0	$I_{OH} = -32mA$	2.0			1	
V _{OL}	Output LOW Vo	Itage	2.7	I _{OL} = 100μA			0.2	V	
				$I_{OL} = 24 \text{mA}$			0.5	1	
			3.0	I _{OL} = 16mA			0.4	1	
				$I_{OL} = 32mA$			0.5	1	
				$I_{OL} = 64 \text{mA}$			0.55	1	
I _{I(HOLD)} ⁽³⁾	Bushold Input Minimum Drive		3.0	$V_{I} = 0.8V$	75			μA	
,				$V_{I} = 2.0V$	-75			1	
I _{I(OD)} ⁽³⁾	Bushold Input C	Bushold Input Over-Drive		(4)	500			μA	
,	Current to Change State			(5)	-500				
I _I	Input Current		3.6	V _I = 5.5V			10	μA	
	Cor	Control Pins	3.6	$V_I = 0V \text{ or } V_{CC}$			±1		
		Data Pins	3.6	$V_I = 0V$			-5	1	
				$V_I = V_{CC}$			1	1	
I _{OFF}	Power Off Leak	age Current	0	$0V \le V_I \text{ or } V_O \le 5.5V$			±100	μA	
I _{PU/PD}	Power up/down 3-STATE Output Current		0–1.5V	$V_O = 0.5V$ to 3.0V, $V_I = GND$ or V_{CC}			±100	μΑ	
I _{OZL}	3-STATE Outpu Current	t Leakage	3.6	$V_{O} = 0.5V$			-5	μA	
I _{OZH}	3-STATE Outpu Current	t Leakage	3.6	V _O = 3.0V			5	μA	
I _{OZH} +	3-STATE Outpu Current	t Leakage	3.6	$V_{CC} < V_O \le 5.5V$			10	μA	
I _{ССН}	Power Supply C	Current	3.6	Outputs HIGH			0.19	mA	
I _{CCL}	Power Supply C	Current	3.6	Outputs LOW			5	mA	
I _{CCZ}	Power Supply C	Current	3.6	Outputs Disabled			0.19	mA	
I _{CCZ} +	Power Supply C	Current	3.6	$V_{CC} \le V_O \le 5.5V$, Outputs Disabled			0.19	mA	
ΔI_{CC}	Increase in Pow Current ⁽⁶⁾	ver Supply	3.6	One Input at $V_{CC} - 0.6V$, Other Inputs at V_{CC} or GND			0.2	mA	

74LVT240, 74LVTH240 — Low Voltage Octal Buffer/Line Driver with 3-STATE Outputs

Notes:

2. All typical values are at $V_{CC} = 3.3V$, $T_A = 25^{\circ}C$.

3. Applies to bushold versions only (74LVTH240).

4. An external driver must source at least the specified current to switch from LOW-to-HIGH.

5. An external driver must sink at least the specified current to switch from HIGH-to-LOW.

6. This is the increase in supply current for each input that is at the specified voltage level rather than V_{CC} or GND.

Dynamic Switching Characteristics⁽⁷⁾

			Conditions	٦	A = 25°	2	
Symbol	Parameter	V _{CC} (V)	$\mathbf{C_L} = \mathbf{50pF}, \mathbf{R_L} = 500\Omega$	Min.	Тур.	Max.	Units
V _{OLP}	Quiet Output Maximum Dynamic V _{OL}	3.3	(8)		0.8		V
V _{OLV}	Quiet Output Minimum Dynamic V _{OL}	3.3	(8)		-0.8		V

Notes:

7. Characterized in SOIC package. Guaranteed parameter, but not tested.

8. Max number of outputs defined as (n). n-1 data inputs are driven 0V to 3V. Output under test held LOW.

AC Electrical Characteristics

				-40°C to - 50pF, R _L =			
		V _{CC}	= 3.3V ±0	0.3V	V _{CC} =	= 2.7V	1
Symbol	Parameter	Min.	Тур. ⁽⁹⁾	Max.	Min.	Max.	Units
t _{PLH}	Propagation Delay, Data to Output	1.1		3.8	1.1	4.6	ns
t _{PHL}		1.3		4.0	1.3	4.2	
t _{PZH}	Output Enable Time	1.1		4.6	1.1	5.6	ns
t _{PZL}	1	1.4		4.4	1.4	5.1]
t _{PHZ}	Output Disable Time	2.0		4.5	2.0	4.7	ns
t _{PLZ}	1	1.8		4.3	1.8	4.3	
t _{OSHL} , t _{OSLH}	Output to Output Skew ⁽¹⁰⁾			1.0		1.0	ns

Notes:

9. All typical values are at V_{CC} = 3.3V, $T_A = 25^{\circ}C$.

 Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}).

Capacitance⁽¹¹⁾

S	Symbol	Parameter	Conditions	Typical	Units
	C _{IN}	Input Capacitance	$V_{CC} = 0V, V_I = 0V \text{ or } V_{CC}$	3	pF
	C _{OUT}	Output Capacitance	$V_{CC} = 3.0$ V, $V_{O} = 0$ V or V_{CC}	6	pF

Note:

11. Capacitance is measured at frequency f = 1MHz, per MIL-STD-883, Method 3012.

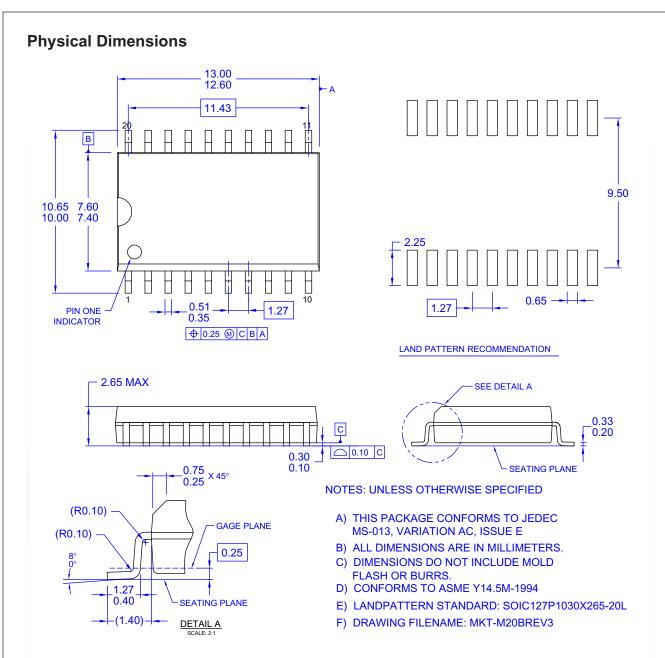
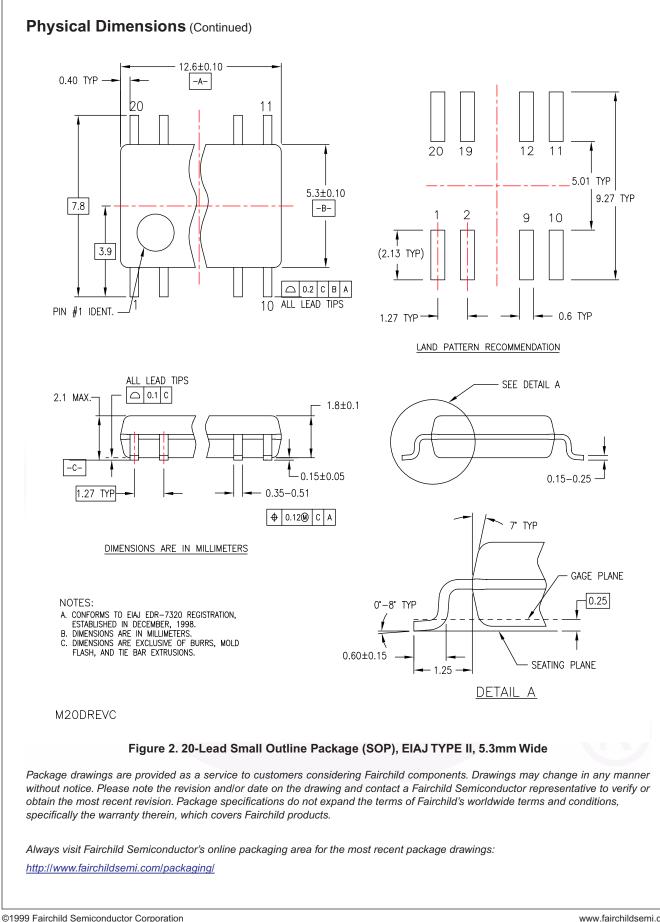


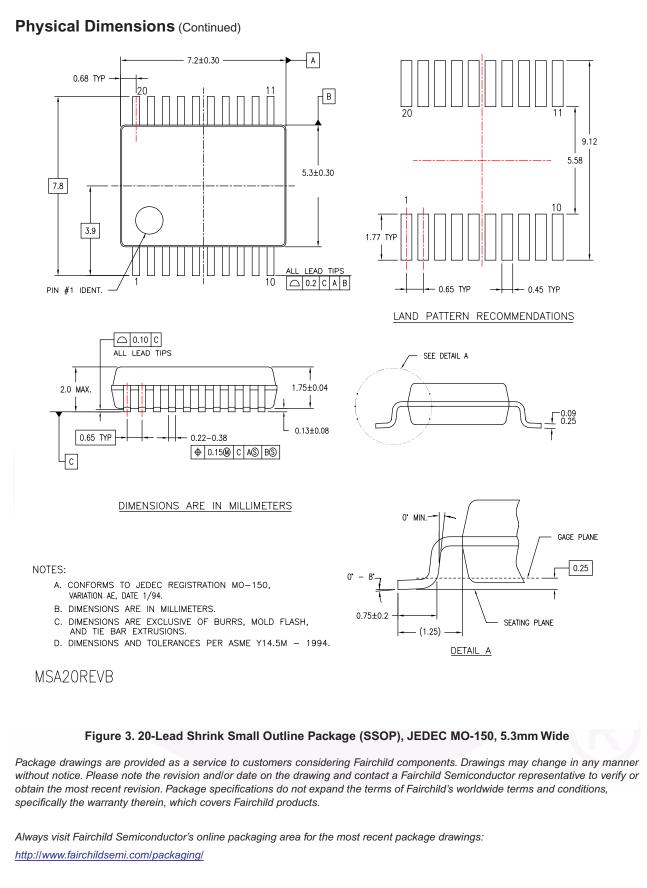
Figure 1. 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide

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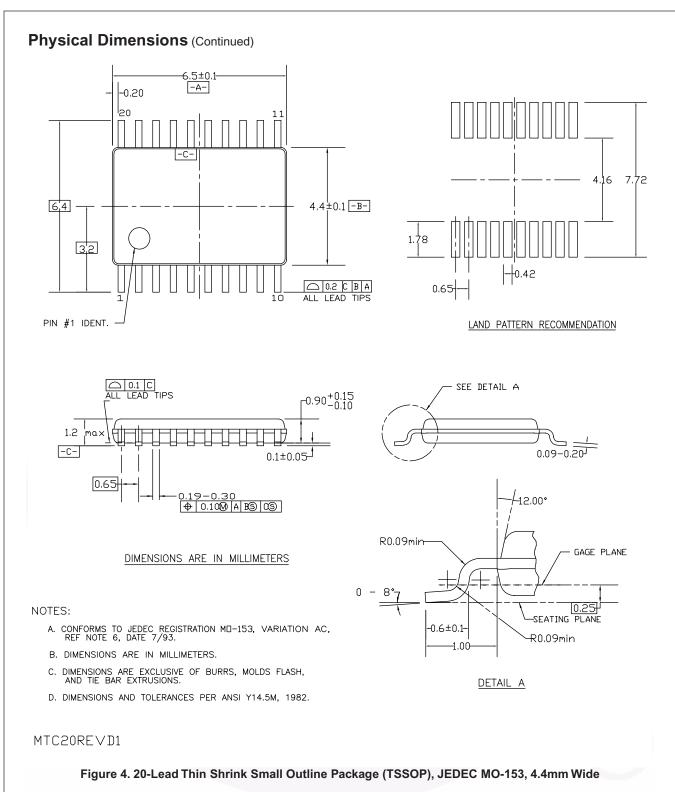


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